

4.2 μm Back side illuminated Photodiode

PD42BS

4.2 μm Back side illuminated Photodiode with microimmersion lens

PD42BSmIL

			Wide Band (WB)		Narrow Band (NB)	
Spectral range	$\lambda_{0.1}$	μm	2.75 ÷ 4.6 (4.7)		3.3 (3.6) ÷ 4.75	
Peak wavelength	$\lambda_{max}$	μm	3.7 ÷ 3.9 @22 °C		3.9 ÷ 4.0 @22 °C	
Current sensitivity at $\lambda_{max}$ according to p-n junction area calculation	$S_i(\lambda_{max})$	A/W	≥2.5		≥4	
Current sensitivity at 4.2 μm	$S_i(\lambda_{3.8 \mu m})$	A/W	≥1.75		≥2.5	
Shunt Resistance	$R_o$	Ohm	≥15		≥30	
Immersion lens			No	mIL	No	mIL
Detectivity	$D^*_{\lambda_{max}}$	cmHz <sup>1/2</sup> W <sup>-1</sup>	≥2.5×10 <sup>9</sup>	≥5×10 <sup>9</sup>	≥5×10 <sup>9</sup>	≥1×10 <sup>10</sup>
Switching time	$\tau$	ns	≤20		according estimation	
Reference wafer			599		598, 601	

Code	Sensitive area, mm	Weight, g	Optical components	Field of view, deg.	Optical axis deviation, deg.	Detectivity deviation in lot, %	Operation conditions, °C
PD42BSTO18		~0.3	-	~140			
PD42BSTO18c	0.35×0.35	~0.3	sapphire window	~60	-	±25	-60÷+85
PD42BSTO18PR		~1	reflector				
PD42BSmILTO18		~0.3	chalcogenide lens				
PD42BSmILTO18c	~D=1	~0.3	sapphire window, chalcogenide lens	≈35	≤5	±25	-60÷+60
PD42BSmILTO39TEC		~1.2	sapphire window, chalcogenide lens				

**PD42BS TO18, PD42BS PRTO18**

Leg near key is negative

**PD42BSmIL TO18, PD42BSmIL TO18c**

Leg near key is negative

**PD42BSmIL TO39TEC**

1 TEC negative;  
2 TEC positive;  
3 PD negative;  
4 PD positive;  
7, 8 thermosensor

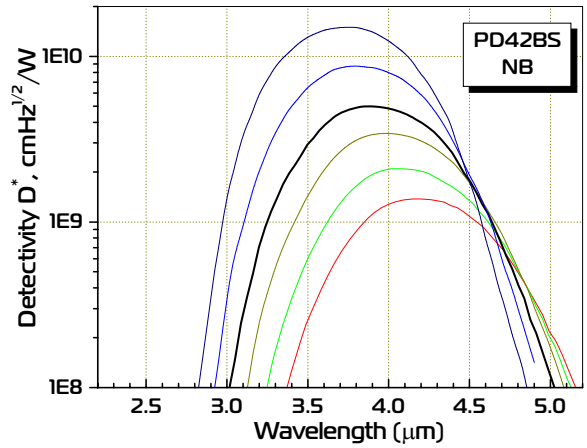
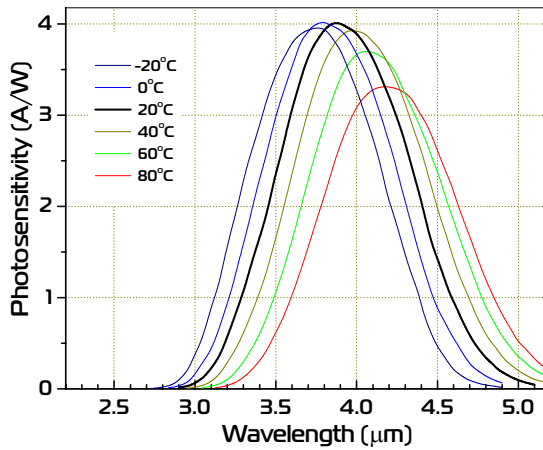
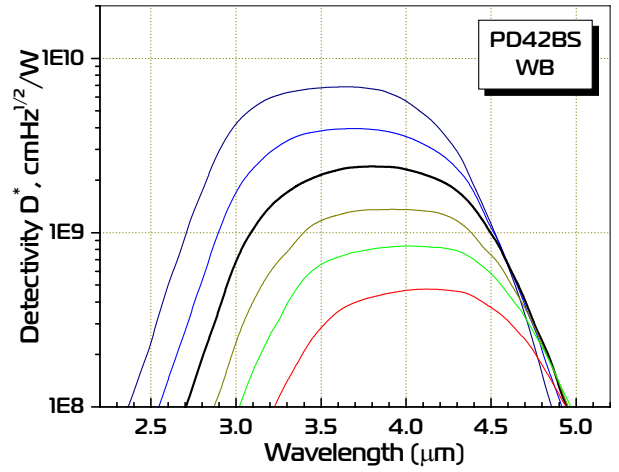
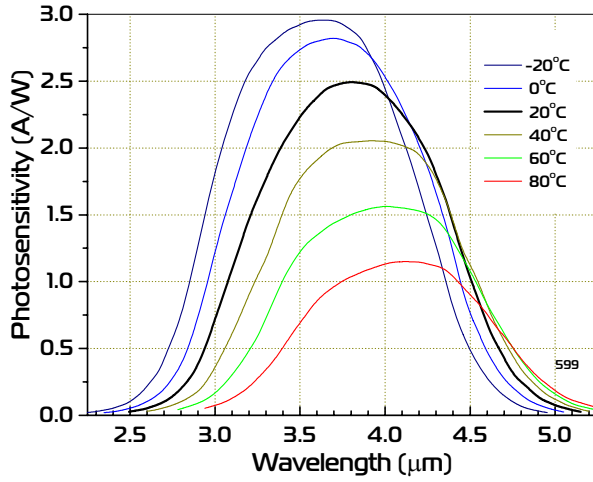
**Features**

- Original growth of narrow gap A3B5 semiconductor alloys onto n<sup>-</sup>-InAs substrate;
- Deep mesa design of PDs;
- Optical coupling through the use of chalcogenide glasses (mIL option)
- Ambient and high temperature operation;
- No bias required;
- Operation from DC to VHF;
- Highest long term stability;
- High value of shunt resistance;

Photodiode could be equipped with preamplifier that is designed for conversion of PD photocurrent into a convenient output voltage and is adjusted for the particular PD taking into account the R<sub>o</sub> value and frequency range. Other packages are available upon request. Data are valid for PD thermostabilized at 22°C. Heatsink is essential for TEC operation!

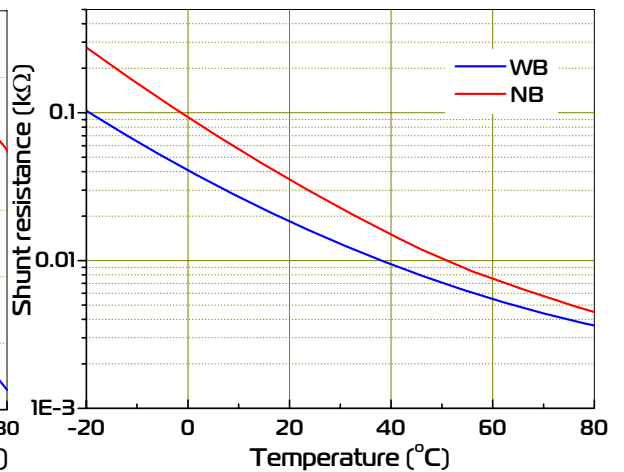
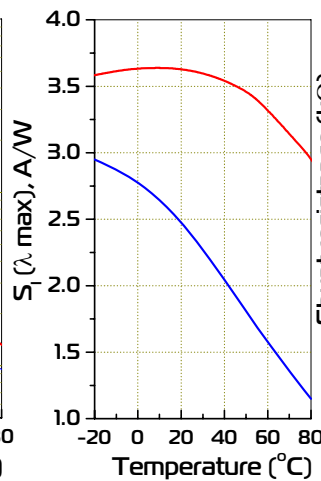
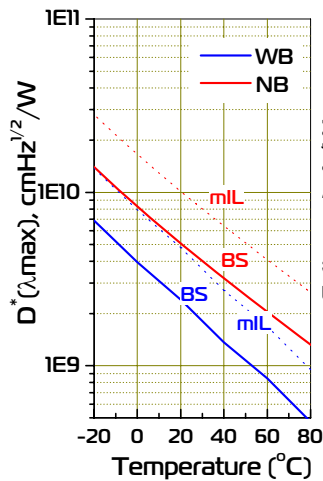
Product specifications are subject to change without prior notice due to improvements or other reasons. Updated 28.10.14

Spectral response



Additional sensitivity in the shortwave spectral range coming from chip edges is allowed (possible)

Detectivity, current sensitivity at  $\lambda_{max}$  and shunt resistance vs. temperature



## Mounted TEC

@ 27 °C, Vacuum

@ 50 °C, N2

1MDO4-011/10

 $\Delta T_{max}$ , K $Q_{max}$ , W $I_{max}$ , A $U_{max}$ , V $\Delta T_{max}$ , K $Q_{max}$ , W $I_{max}$ , A $U_{max}$ , V

69

0.54

0.7

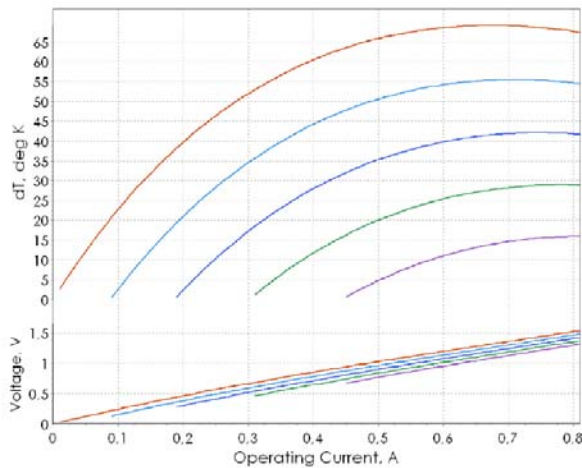
1.3

72

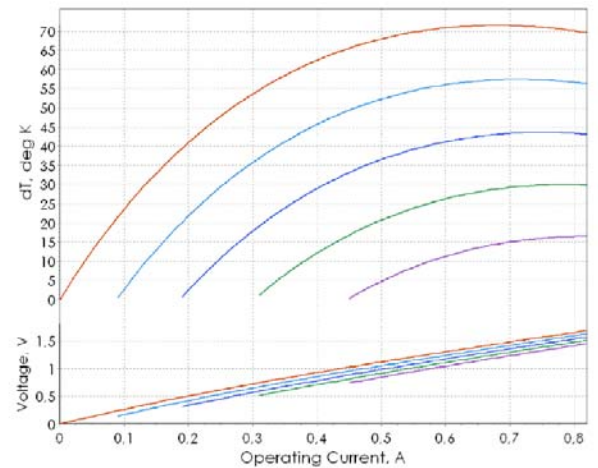
0.6

0.7

1.4



Heatload, W  
 — 0,00 — 0,11 — 0,22 — 0,33 — 0,44



Heatload, W  
 — 0,00 — 0,12 — 0,24 — 0,36 — 0,48

Data from www.tec-microsystems.com; www.rmtltd.ru

## Type TB04-103

T, °C	R, kΩ	T, °C	R, kΩ
-60	1134.5	15	12.44
-55	762.4	20	10.00
-50	521.6	25	8.09
-45	362.8	25	8.09
-40	256.3	30	6.60
-35	183.8	35	5.41
-30	133.6	40	4.47
-25	98.3	45	3.71
-20	73.3	50	3.10
-15	55.2	55	2.61
-10	42.1	60	2.20
-5	32.4	65	1.87
0	25.2	70	1.59
5	19.7	75	1.37
10	15.6	80	1.18

